



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

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Features

- Planar Die Construction
- Small Surface Mount Package
- General Purpose
- Ideally Suited for Automated Assembly Processes
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

Mechanical Data

- Case: SOD323
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Solderable per MIL-STD-202, Method 208 ③
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe). Polarity: Cathode Band
- Weight: 0.004 grams (approximate)



Top View

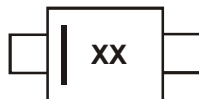
Ordering Information (Note 4)

Part Number	Case	Packaging
(Type Number)-7-F*	SOD-323	3000/Tape & Reel
(Type Number)-13-F* (Note 5)	SOD-323	10000/Tape & Reel

* For (Type Number), please see the Electrical Characteristics Table. Example: 6.2V Zener = MMSZ5234BS-7-F.

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>
 5. Devices are readily available on 13" reels for select voltages only. For other voltages, devices can be made available on 13" reels upon request. Please contact your Diodes Inc. sales representative for additional details.

Marking Information



XX = Product Type Marking Code
(See Electrical Characteristics Table)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Forward Voltage (Note 6) @ I _F = 10mA	V _F	0.9	V

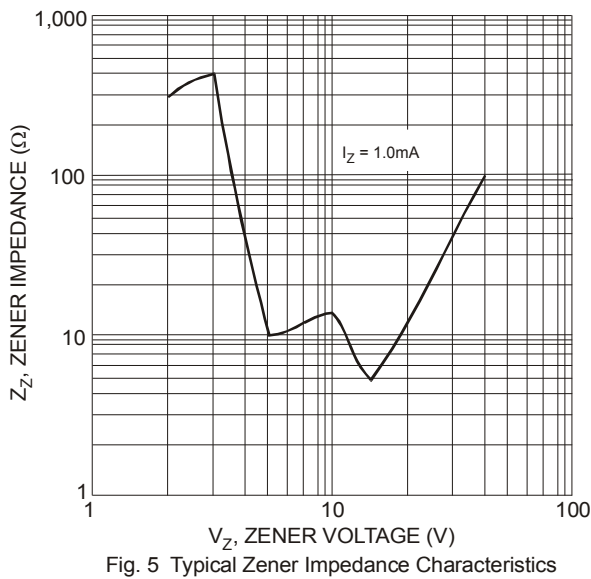
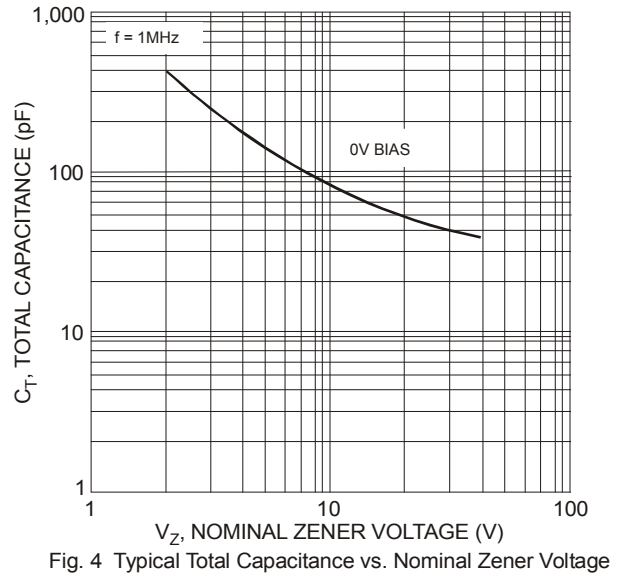
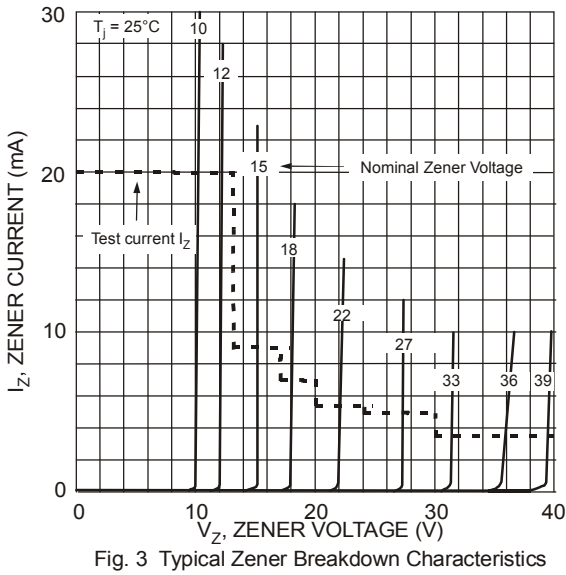
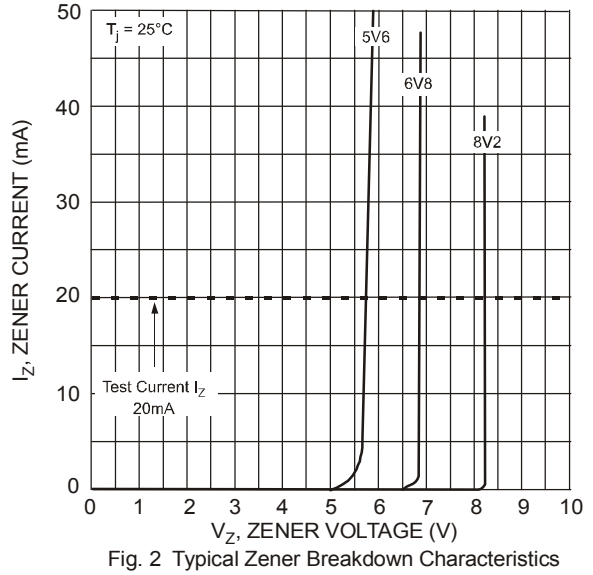
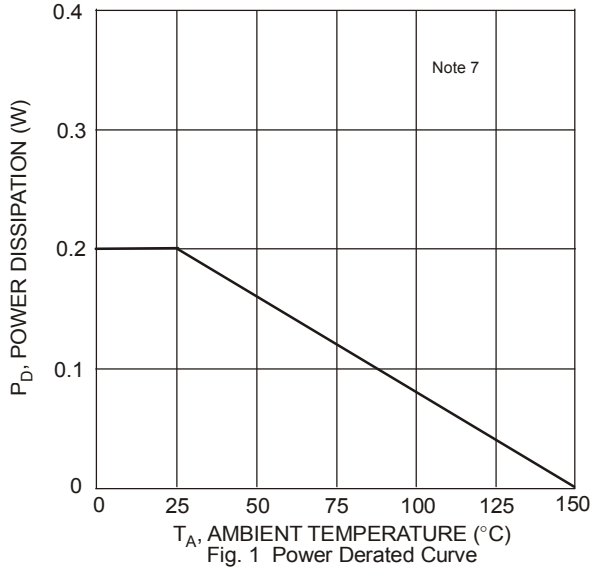
Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 7)	P _D	200	mW
Thermal Resistance, Junction to Ambient Air (Note 7)	R _{θJA}	625	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

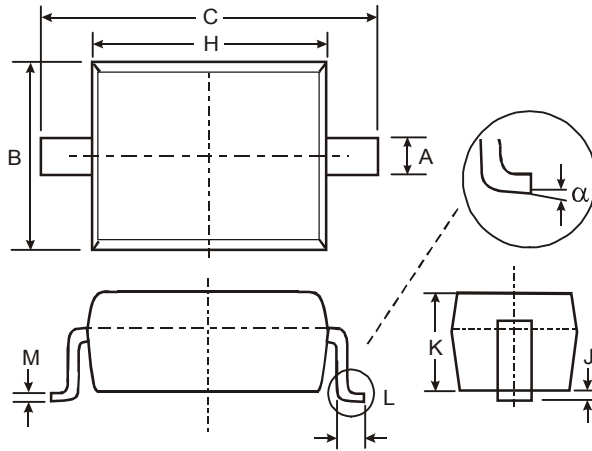
Type Number	Marking Code	Zener Voltage Range (Note 8)			Test Current	Maximum Zener Impedance (Note 9)		Maximum Reverse Leakage Current (Note 8)	
		V _Z @ I _{ZT}				I _{ZT}	Z _{ZT} @ I _{ZT}	Z _{ZK} @ I _{ZK} = 0.25mA	I _R
		Nom (V)	Min (V)	Max (V)	mA				
MMSZ5221BS	C1	2.4	2.28	2.52	20	30	1200	100	1.0
MMSZ5223BS	C3	2.7	2.57	2.84	20	30	1300	75	1.0
MMSZ5225BS	C5	3.0	2.85	3.15	20	30	1600	50	1.0
MMSZ5226BS	G1	3.3	3.14	3.47	20	28	1600	25	1.0
MMSZ5227BS	G2	3.6	3.42	3.78	20	24	1700	15	1.0
MMSZ5228BS	G3	3.9	3.71	4.10	20	23	1900	10	1.0
MMSZ5229BS	G4	4.3	4.09	4.52	20	22	2000	5.0	1.0
MMSZ5230BS	G5	4.7	4.47	4.94	20	19	1900	5.0	2.0
MMSZ5231BS	E1	5.1	4.85	5.36	20	17	1600	5.0	2.0
MMSZ5232BS	E2	5.6	5.32	5.88	20	11	1600	5.0	3.0
MMSZ5233BS	E3	6.0	5.70	6.30	20	7	1600	5.0	3.5
MMSZ5234BS	E4	6.2	5.89	6.51	20	7	1000	5.0	4.0
MMSZ5235BS	E5	6.8	6.46	7.14	20	5	750	3.0	5.0
MMSZ5236BS	F1	7.5	7.13	7.88	20	6	500	3.0	6.0
MMSZ5237BS	F2	8.2	7.79	8.61	20	8	500	3.0	6.5
MMSZ5238BS	F3	8.7	8.27	9.14	20	8	600	3.0	6.5
MMSZ5239BS	F4	9.1	8.65	9.56	20	10	600	3.0	7.0
MMSZ5240BS	F5	10	9.50	10.50	20	17	600	3.0	8.0
MMSZ5241BS	H1	11	10.45	11.55	20	22	600	2.0	8.4
MMSZ5242BS	H2	12	11.40	12.60	20	30	600	1.0	9.1
MMSZ5243BS	H3	13	12.35	13.65	9.5	13	600	0.5	9.9
MMSZ5245BS	H5	15	14.25	15.75	8.5	16	600	0.1	11
MMSZ5246BS	J1	16	15.20	16.80	7.8	17	600	0.1	12
MMSZ5248BS	J3	18	17.10	18.90	7.0	21	600	0.1	14
MMSZ5250BS	J5	20	19.00	21.00	6.2	25	600	0.1	15
MMSZ5251BS	K1	22	20.90	23.10	5.6	29	600	0.1	17
MMSZ5252BS	K2	24	22.80	25.20	5.2	33	600	0.1	18
MMSZ5254BS	K4	27	25.65	28.35	5.0	41	600	0.1	21
MMSZ5255BS	K5	28	26.60	29.40	4.5	44	600	0.1	21
MMSZ5256BS	M1	30	28.50	31.50	4.2	49	600	0.1	23
MMSZ5257BS	M2	33	31.35	34.65	3.8	58	700	0.1	25
MMSZ5258BS	M3	36	34.20	37.80	3.4	70	700	0.1	27
MMSZ5259BS	M4	39	37.05	40.95	3.2	80	800	0.1	30

- Notes:
6. Short duration pulse test used to minimize self-heating effect.
 7. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>
 8. Short duration pulse test used to minimize self-heating effect.
 9. f = 1KHz.



Package Outline Dimensions

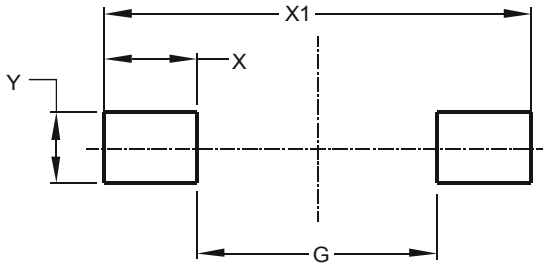
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



SOD323		
Dim	Min	Max
A	0.25	0.35
B	1.20	1.40
C	2.30	2.70
H	1.60	1.80
J	0.00	0.10
K	1.0	1.1
L	0.20	0.40
M	0.10	0.15
α	0°	8°
All Dimensions in mm		

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for latest version.



Dimensions	Value (in mm)
G	1.520
X	0.590
X1	2.700
Y	0.450

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